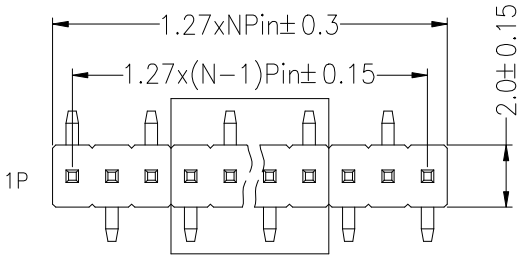
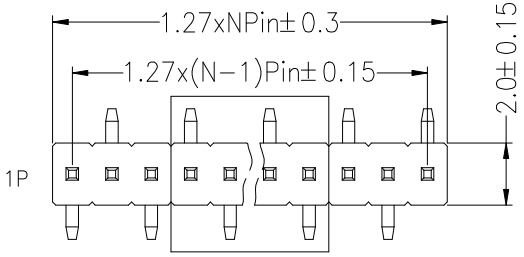
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

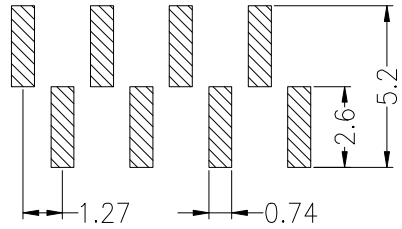
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



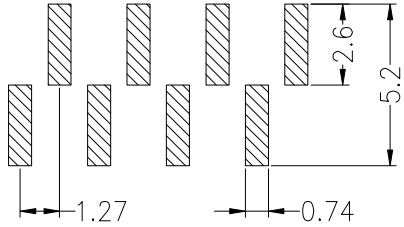


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

TYPE2



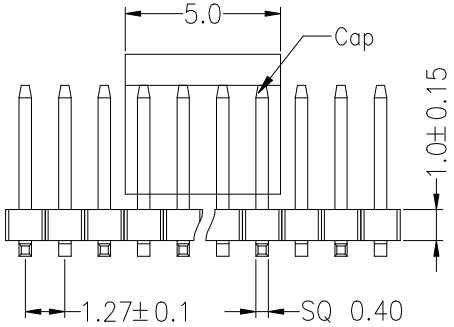
TYPE1

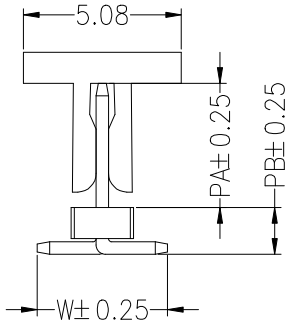


Ordering Information

1410 1 1 XX X N XX M XXX X 0X

- No.of Pins Per Row: 2~50P
- Insulator Material Option: C=BK−PA6T, E=BK−PA9T, F=BK−LCP
- Contact Plating: G1:1U" Gold, G2:1.5U" Gold, G3:2U" Gold, G4:3U" Gold, G5:5U" Gold, S0:Gold Flash/Tin, SN:Tin
- Pin Length
- Packing: 0=PE Bag, A=Tray, T=Tube, P=Tube+Cap, R=Reel+Cap
- Series No. 01~99





Dimension antitheses list			
ITEM	PA	PB	W
Standard	4.00	1.50	4.20

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2018.03.28	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW: Liu Miao 18.03.28
CHECK:
APPROVE:

SCALE: FIT
UNIT: mm
SIZE: A4
SHEET: 1/1
PROJ.:

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.: 141011XXXNXXMXXXX0X
TITLE: 1.27PH H1.0mm 1xNpin SMT **带夹持盖**